

Dual N-Channel Enhancement Mode MOSFET

1. Product Information

1.1 Features

- ☑ Surface-mounted package
 - ☑ Super Trench
- ☑ Low Thermal Resistance
 - ☑ Low ciss

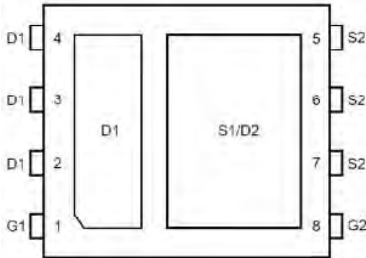
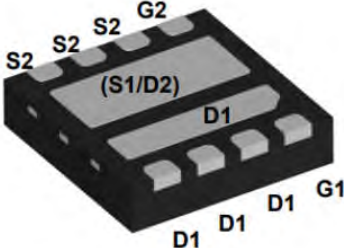
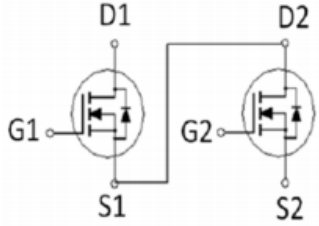
1.2 Applications

- ☑ Motor drivers
- ☑ DC - DC Converter

1.3 Quick reference

- ☑ $BV \leq 45 \text{ V}$
 - ☑ $P_{tot} \leq 20.8 \text{ W}$
 - ☑ $I_D \leq 40 \text{ A}$
- ☑ $R_{DS(ON)} \leq 8 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$
 - ☑ $R_{DS(ON)} \leq 13 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$

2. Pin Description

Pin	Description	Simplified Outline	Symbol
  DFN3x3 			

3. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	Drain-Source Voltage	$T_C = 25\text{ }^{\circ}\text{C}$	45	-	V
V_{GS}	Gate-Source Voltage	$T_C = 25\text{ }^{\circ}\text{C}$	-	± 20	V
I_D^*	Drain Current	$T_C = 25\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$	-	40	A
$I_{DM}^{*,***}$	Pulsed Source Current	$T_C = 25\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$	-	96	A
P_{tot}^*	Total Power Dissipation	$T_C = 25\text{ }^{\circ}\text{C}$	-	20.8	W
T_{stg}	Storage Temperature		- 55	150	$^{\circ}\text{C}$
T_J	Junction Temperature		-	150	$^{\circ}\text{C}$
I_S	Diode Forward Current	$T_C = 25\text{ }^{\circ}\text{C}$	-	40	A
E_{AS}^*	Single Pulsed Avalanche Energy	$V_{DD} = 45\text{ V}, L = 1\text{ mH}$	-	66	mJ
$R_{\theta JA}^*$	Thermal Resistance- Junction to Ambient		-	62.5	$^{\circ}\text{C} / \text{W}$
$R_{\theta JC}^*$	Thermal Resistance- Junction to Case		-	6	

Notes :

- * Surface Mounted on 1 in² pad area, $t \leq 10\text{ sec}$
- ** Pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
- *** limited by bonding wire

4. Marking Information

Product Name	Marking
UD3045CQ	3045C YWWXXX YWWXXXX : Date Code

5. Ordering Code

Product Name	Package	Reel Size	Tape width	Quantity	Note
UD3045CQ	DFN3*3			5000	

Note: UOE defines "Green" as lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C)

6. Electrical Characteristics (T_A = 25 °C Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	45	-	-	V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _{DS} = 250 μA	1	-	2	V
I _{DSS}	Zero Gate Voltage Source Current	V _{DS} = 36 V, V _{GS} = 0 V	-	-	1	μA
		T _J = 85 °C	-	-	30	μA
I _{GSS}	Gate Leakage Current	V _{GS} = ± 20 V, V _{DS} = 0 V	-	-	± 100	nA
R _{DS(ON)} ^a	Drain-Source On-State Resistance	V _{GS} = 10 V, I _D = 20 A	-	7.5	8	mΩ
		V _{GS} = 4.5 V, I _D = 10 A	-	12.5	13	
Diode Characteristics						
V _{SD} ^a	Diode Forward Voltage	I _{SD} = 20 A, V _{GS} = 0 V	-	-	1.3	V
t _{rr}	Reverse Recovery Time	I _{SD} = 20 A, dI _{SD} /dt = 100 A/μs	-	26	-	nS
Q _{rr}	Reverse Recovery Charge		-	8.8	-	nC
Dynamic Characteristics ^b						
C _{iss}	Input Capacitance	V _{GS} = 0 V, V _{DS} = 22.5 V Frequency = 1 MHz	-	708	-	pF
C _{oss}	Output Capacitance		-	184	-	
C _{rss}	Reverse Transfer Capacitance		-	34	-	
t _{d(on)}	Turn-on Delay Time	V _{DS} = 22.5 V, V _{GEN} = 10 V, R _G = 4.5 Ω, R _L = 1.12 Ω, I _D = 20 A	-	5.1	-	nS
t _r	Turn-on Rise Time		-	41	-	
t _{d(off)}	Turn-off Delay Time		-	14	-	
t _f	Turn-off Fall Time		-	7.4	-	
Gate Charge Characteristics ^b						
Q _g	Total Gate Charge	V _{GS} = 10 V, V _{DS} = 22.5 V, I _{DS} = 20 A	-	14	-	nC
Q _{gs}	Gate-Source Charge		-	3.1	-	
Q _{gd}	Gate-Drain Charge		-	2.9	-	

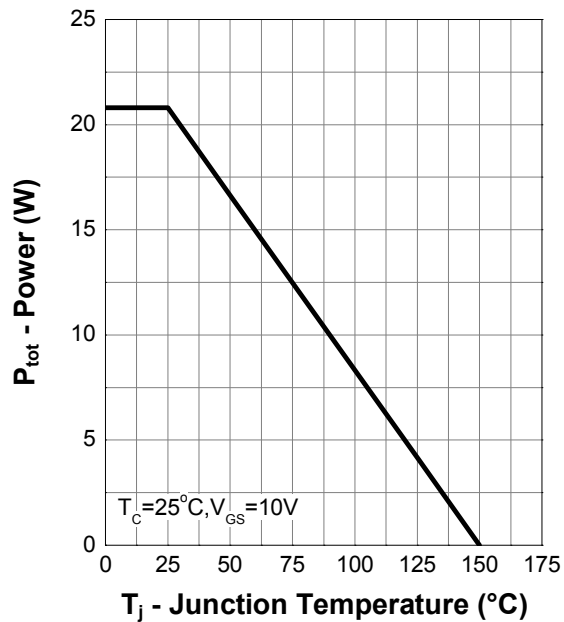
Notes :

a : Pulse test ; pulse width ≤ 300 μs, duty cycle ≤ 2 %

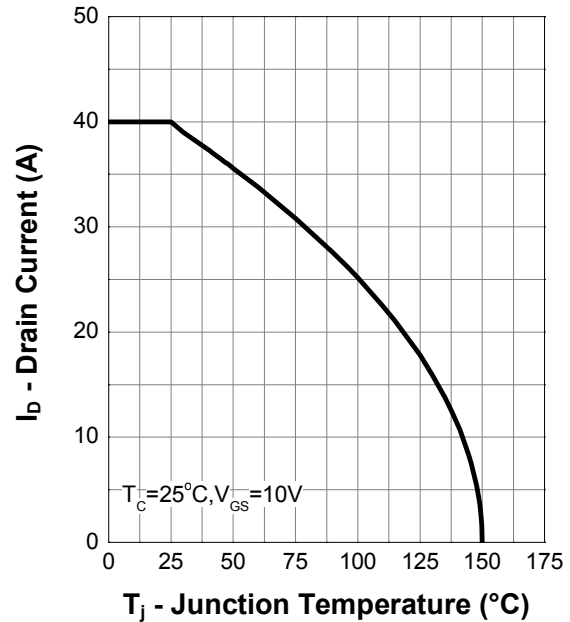
b : Guaranteed by design, not subject to production testing

7. Typical Characteristics (Cont.)

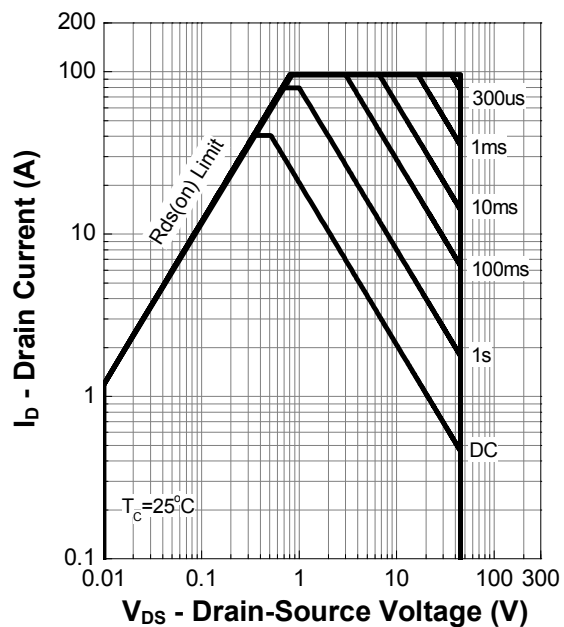
Power Capability



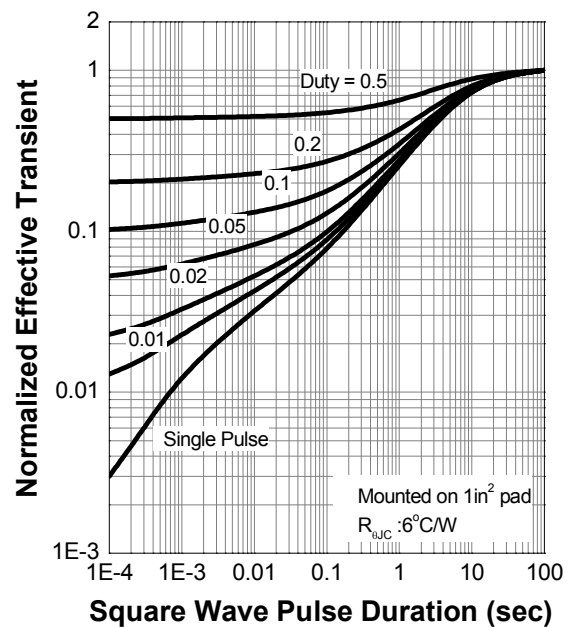
Current Capability



Safe Operation Area

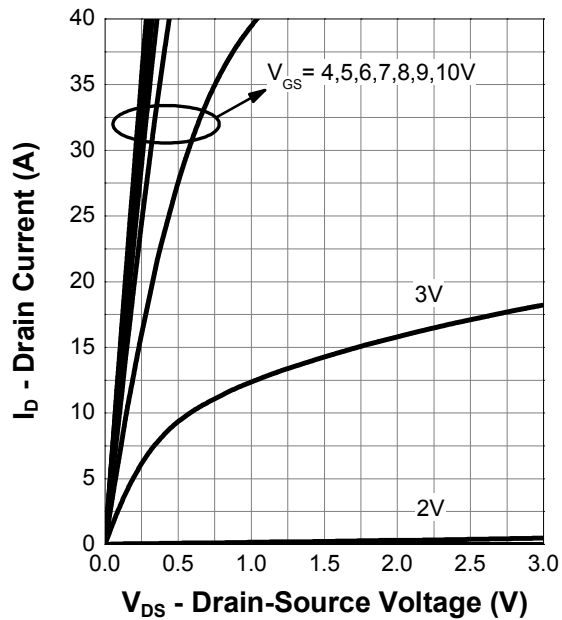


Transient Thermal Impedance

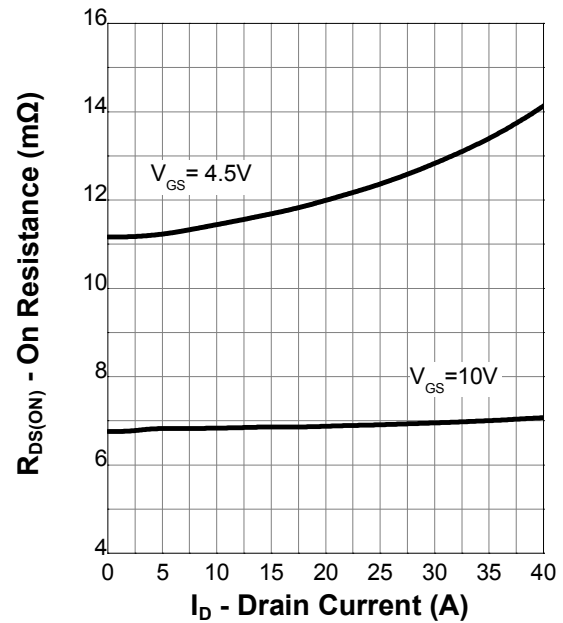


7. Typical Characteristics (Cont.)

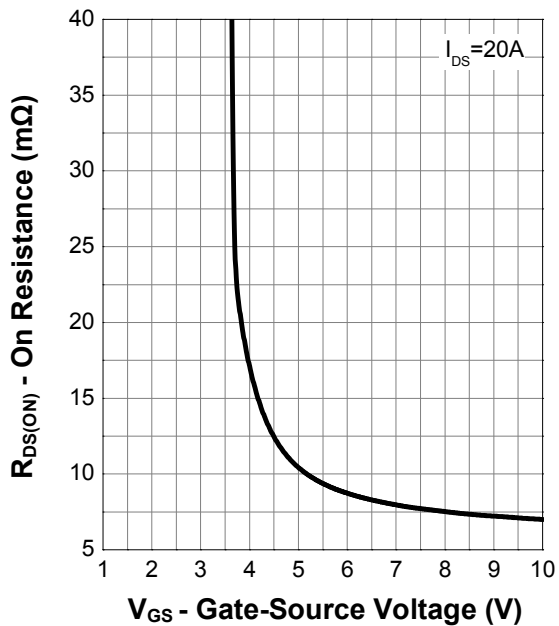
Output Characteristics



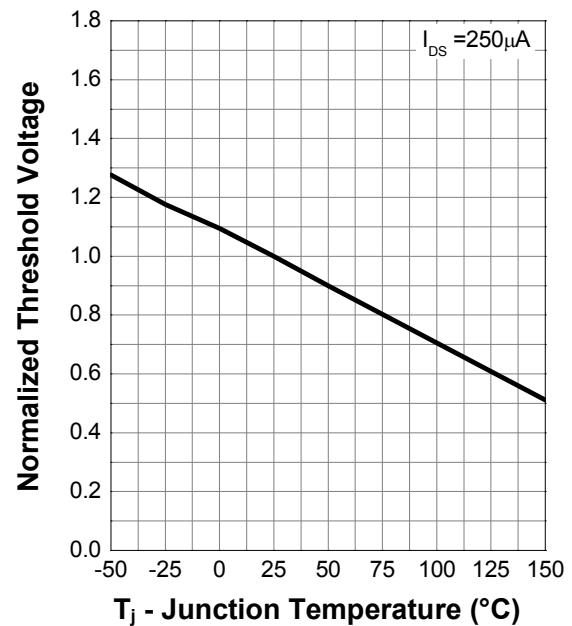
On Resistance



Transfer Characteristics

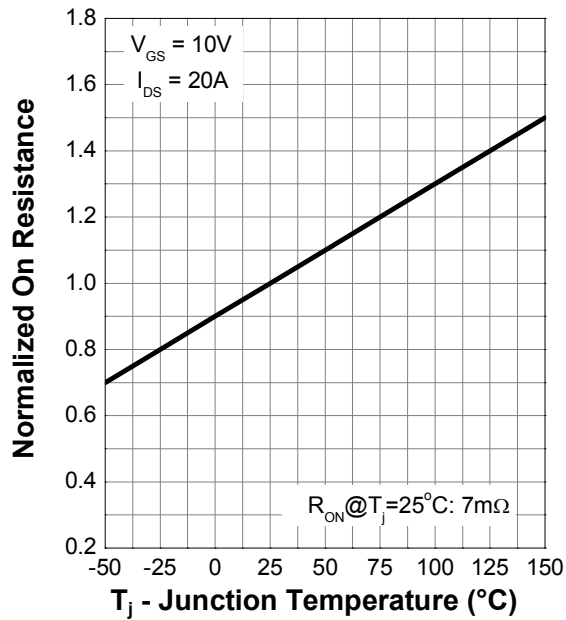


Normalized Threshold Voltage

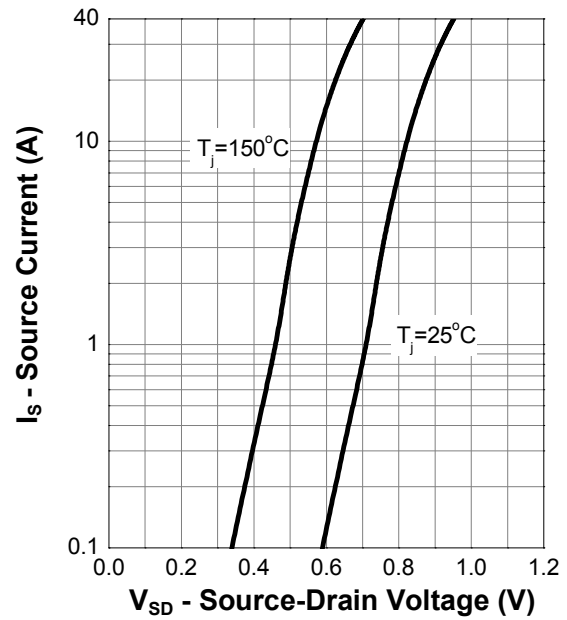


7. Typical Characteristics (Cont.)

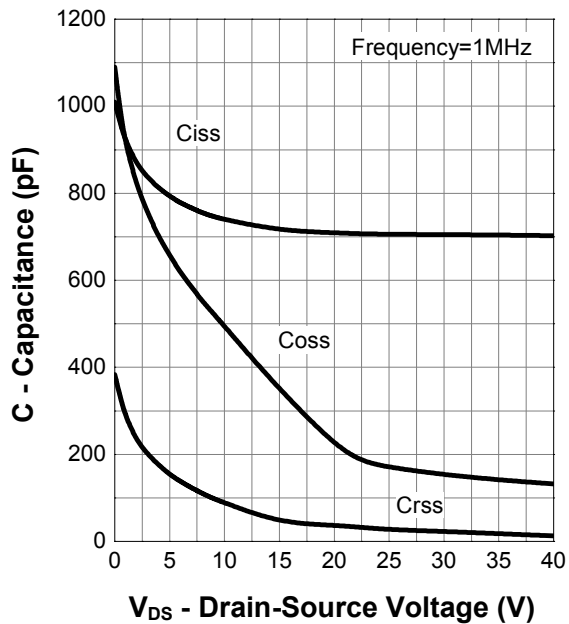
Normalized On Resistance



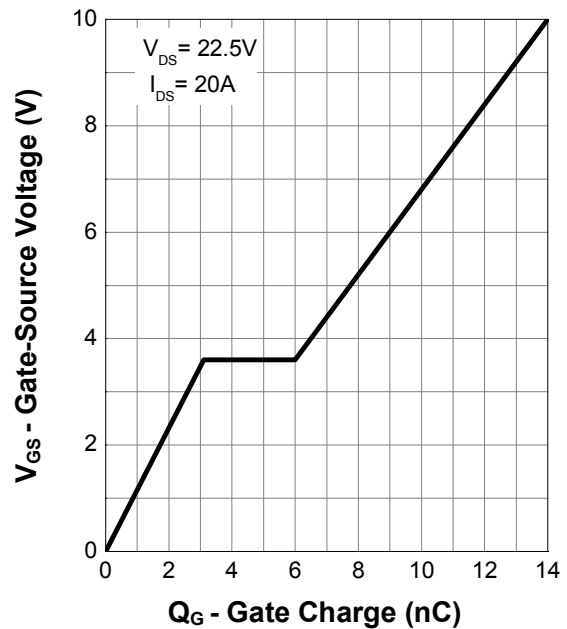
Diode Forward Current



Capacitance

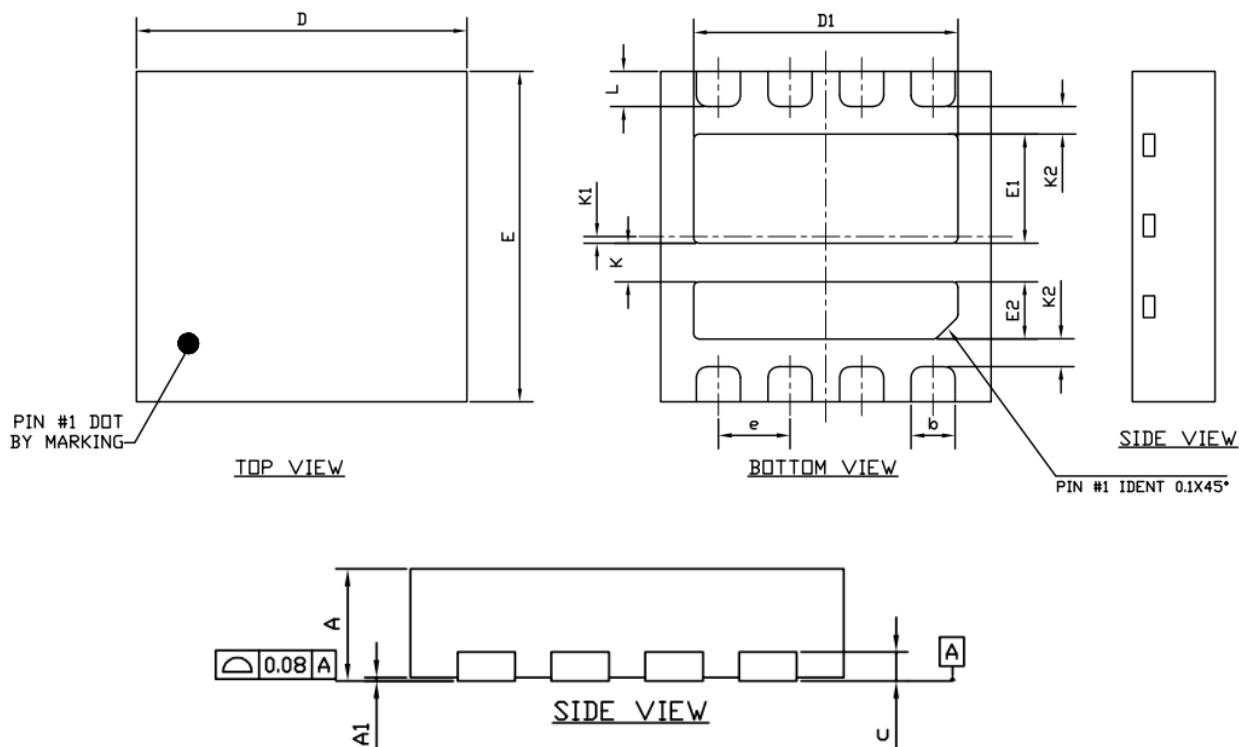


Gate Charge



8. Package Dimensions

DFN3*3



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.70	0.75	0.80	0.028	0.030	0.032
A1	0.00	---	0.05	0.000	---	0.002
c	0.203 REF.			0.008 REF.		
b	0.35	0.40	0.45	0.014	0.016	0.018
D	2.90	3.00	3.10	0.114	0.118	0.122
D1	2.30	2.40	2.50	0.090	0.094	0.098
E	2.90	3.00	3.10	0.114	0.118	0.122
E1	0.89	0.99	1.09	0.035	0.039	0.043
E2	0.42	0.52	0.62	0.016	0.020	0.024
e	0.65 BSC			0.026 BSC		
L	0.27	0.32	0.37	0.011	0.013	0.015
K	0.35 REF.			0.014 REF.		
K1	0.06 REF.			0.002 REF.		
K2	0.25 REF.			0.010 REF.		